

ULTRA LOW LEAKAGE SURFACE MOUNT FAST SWITCHING DIODE

Features

- Ultra-Small, Leadless Surface Mount Package (1.0 x 0.6mm)
- Ultra-Low Profile Package (0.4mm)
- Fast Switching Speed, Fast Reverse Recovery Time
- Ultra-Low Reverse Leakage Current (~ 5nA @ V_R = 5V)
- Very Low Capacitance (<1pF @ V_R=0V)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X2-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar (See Marking Information)
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)

X2-DFN1006-2



Bottom View

2	
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Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DLLFSD01LPH4-7B	Standard	X2-DFN1006-2	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

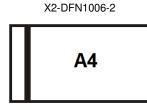
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



A4 = Product Type Marking Code

Top View Bar Denotes Cathode Side



Maximum Ratings (@T_A = +25°C, unless otherwise specified.

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	85	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} VR	80	V
RMS Reverse Voltage	V _{R(RMS)}	57	V
Forward Continuous Current	I _{FM}	300	mA
Average Rectified Output Current	Io	100	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs	I _{FSM}	2.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{0JA}	357	°C/W
Operating and Storage Temperature Range	T_J , T_STG	-65 to +150	°C

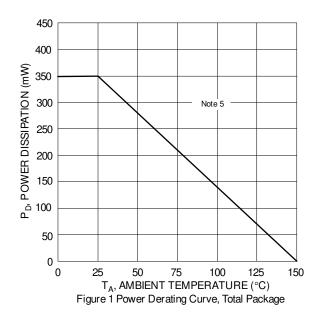
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

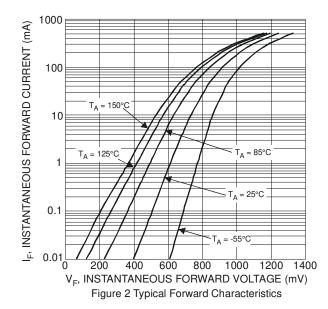
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	80	—	—	V	I _R = 100μA
Forward Voltage	VF		0.62 0.74 0.94	0.7 0.82 1.20	v	$\begin{split} I_F &= 1.0 mA \\ I_F &= 10 mA \\ I_F &= 100 mA \end{split}$
Leakage Current (Note 6)	I _R	 	5 — —	10.0 0.1 0.2	nΑ μΑ μΑ	V _R = 5V V _R = 30V V _R = 80V
Total Capacitance	CT	_	0.5	2.5	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_		4.0 4.0	ns ns	$\begin{split} I_{F} &= 10 \text{mA}, \ V_{R} = 6 \text{V} \\ I_{F} &= I_{R} = 10 \text{mA}, \\ I_{rr} &= 0.1 \times I_{R}, \ R_{L} = 100 \Omega \end{split}$

Notes:

5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.

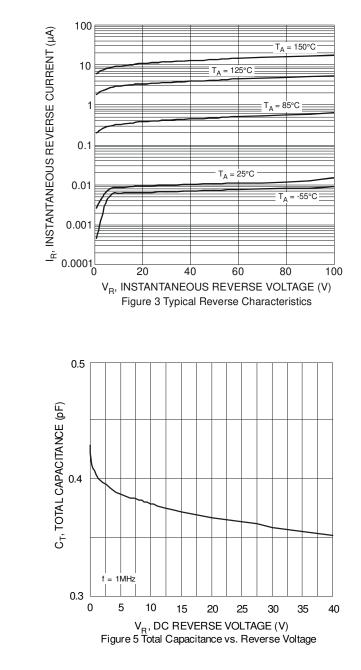
6. Short duration pulse test used to minimize self-heating effect.

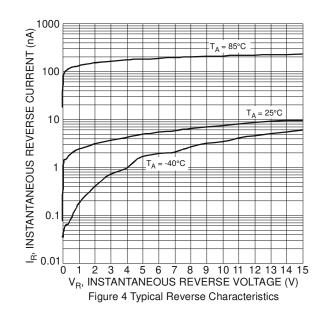






DLLFSD01LPH4

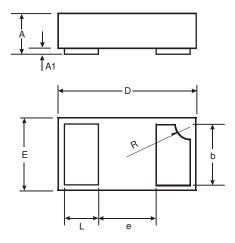






Package Outline Dimensions

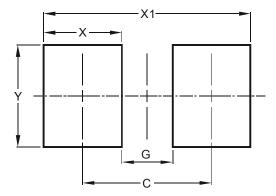
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X2-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.34	0.4	0.37	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	-	-	0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		



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